



SNM-301-ARP7  
W12.30xD10.10xH1.25

PIN 数(Number of contacts) : 6+1PIN

耐电压(Withstand voltage) : 500V AC for 1 min

操作方式(Operation mode): 推拉式/PUSH PULL

操作寿命(Operation life): 5,000 Cycles Min

温度范围(Operating temp): -40°C TO +80°C

焊接温度(Welding temperature): 260±5° 5s

额定负荷(Rated load): 0.5A PERP IN.

焊接方式(Welding mode): 贴片式/SMT

接触电阻(Contact resistance): 100mΩ max.

包装方式(Packaging method): 卷带/Tape & Reel (TR)

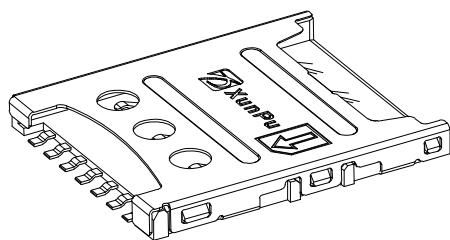
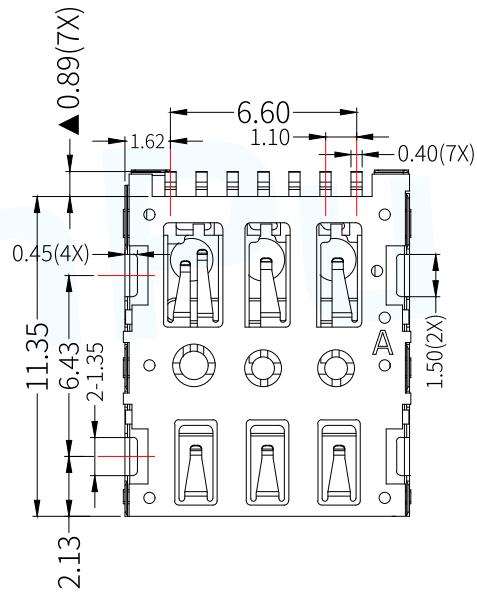
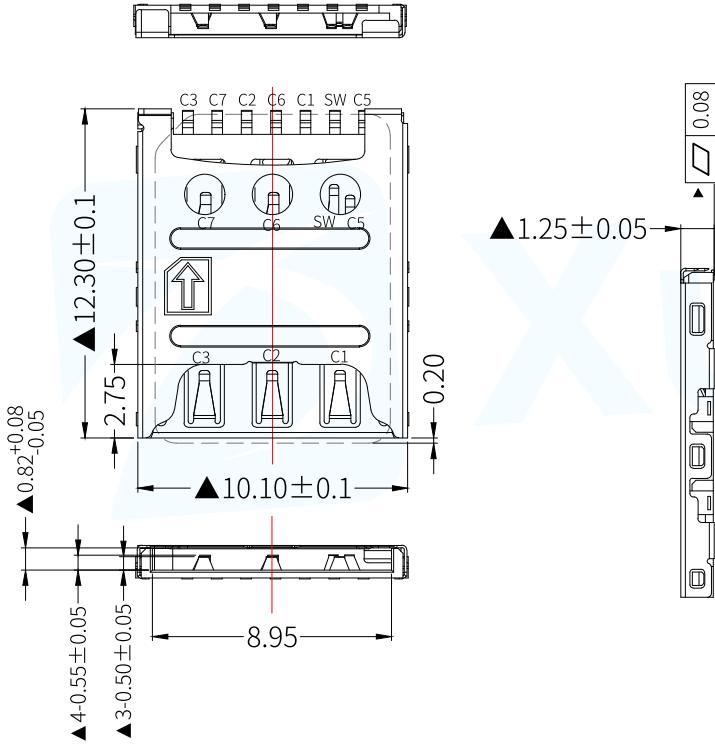
绝缘电阻(Insulation resistance): 1000MΩ min.

最小包装(Minimum packing): 2,200/PCS

## 外形尺寸(UNIT:MM) / Size Chart

[www.xunpudianzi.com](http://www.xunpudianzi.com)

更多资料请参考技术选型档!



## NOTES

### 1. MATERIAL:

1-1. HOUSING: THERMOPLASTIC,UL 94-V0

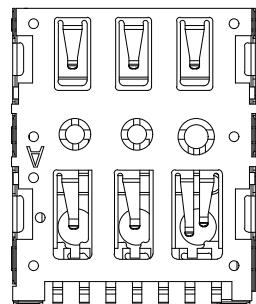
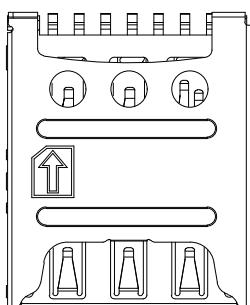
1-2. TERMINAL: PHOSPHOR BRONZE,T=0.10

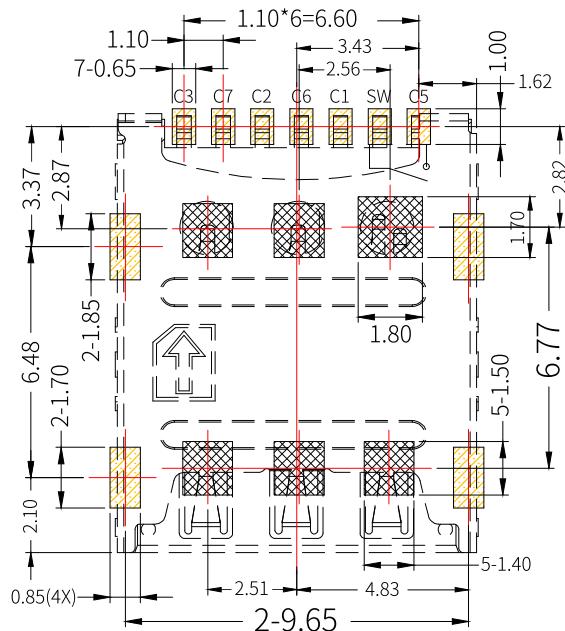
1-3. SHELL: STAINLESS STEEL,T=0.10

### 2. FINISHED:

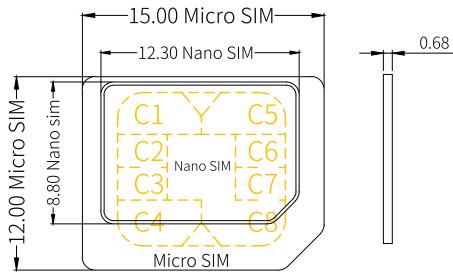
2-1. TERMINAL: Ni PLATED UNDER,Au PLATED ON  
CONTACT AREA,G/F PLATED ON SOLDER TAIL

2-2. SHELL: Ni PLATED UNDER,G/F PLATED ON SOLDER TAIL





## NANO SIM



## 引脚定义/Pin Definition

SIM PIN ASSIGNMENT			
PIN#	NAME	TYPE	DESCRIPTION
C1	供电电压	1	VCC
C2	重置	1	RST
C3	时钟	1	CLK
C5	接地	1	GND
C6	程序电压	1	VPP
C7	输入输出	1	I/O
SW	卡检测开关		Card Detect Switch

Circuit Diagram for Detect Switch

PCB焊盘区(PAD AREA)  
禁区(KEEP OUT AREA)

RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE  $\pm 0.05$

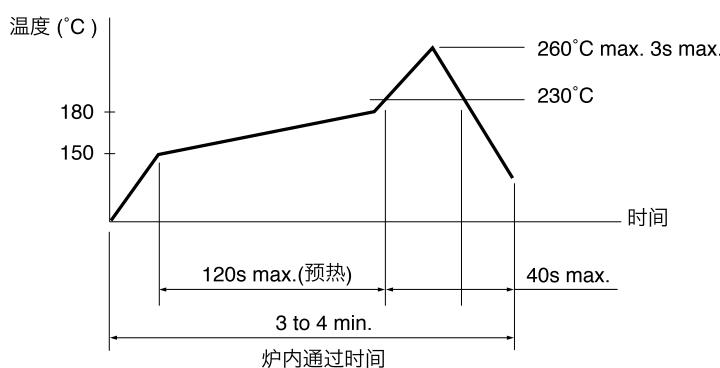
WITHOUT CARD	OPEN	OPEN SW C5
INSERTING CARD	CLOSE	CLOSE SW C5

## 焊接条件 / Welding conditions

## 回流焊/Reflow soldering

适用表面贴装型产品/Applicable to surface mount products

温度分布/Temperature distribution



## 手焊式/Hand welding

项目/Project	条件/condition
焊接温度 Welding temperature	350°C max.
持续焊接时间 Continuous welding time	3s max.
焊剂斗容量 Flux bucket capacity	60W max.

## 浸焊式/Immersion soldering

项目/Project	条件/condition
助焊剂附着量 Flux adhesion	不附着于零部件贴装面的程度 Not attached to the mounting surface of components
预热温度 Preheating temperature	印刷电路板焊接面的周围温度 100°C max. The temperature around the welding surface of PCB is 100 °C max
预热温度时间 Preheat temperature time	60s max.
焊接温度 welding temperature	260°C max.
焊接浸渍时间 Welding immersion time	5s max.
焊接次数 Welding times	2 times max.

## 注:

- 加热方式:以远红外线上下加热方式。
- 温度测量:用Φ0.1~0.2 的 CA(K) 或 CC(T) 测量位置在焊接连接部(锡/铜箔面)。
- 固定方式:采用耐热胶带。